Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon NPN Epitaxial

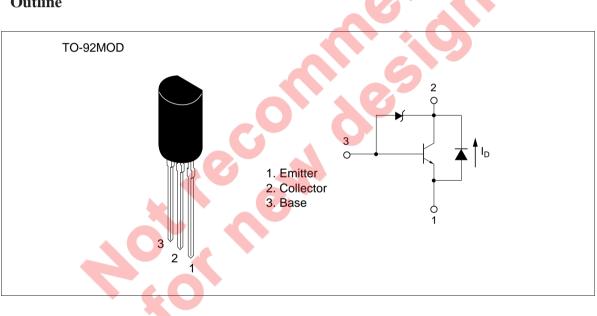
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ADE-208-1160 (Z) 1st. Edition Mar. 2001

Application

Low frequency power amplifier

Outline



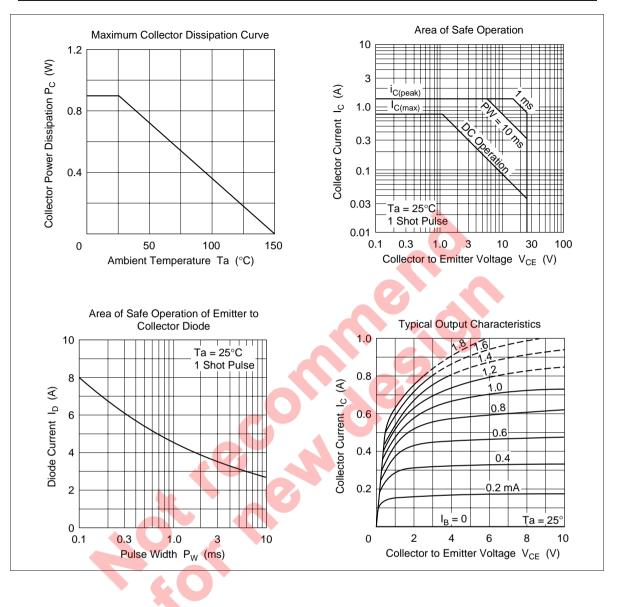
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

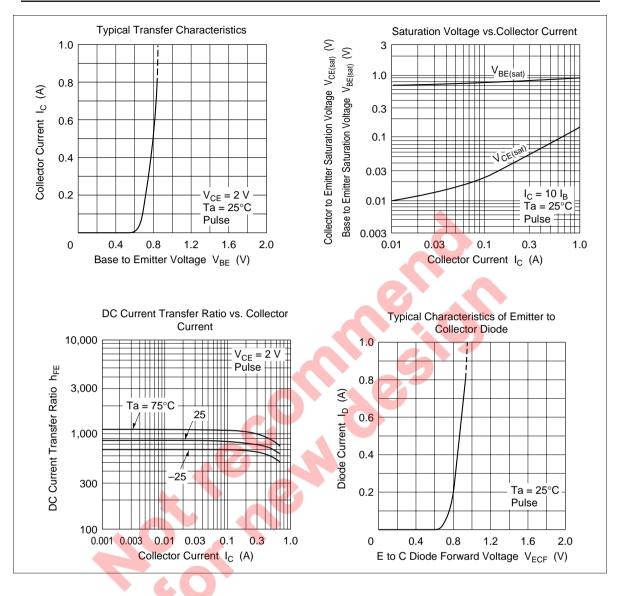
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	25	V
Collector to emitter voltage	V _{CEO}	25	V
Emitter to base voltage	V _{EBO}	6	V
Collector current	Ι _c	0.8	А
Collector peak current	ic (peak)	1.5	A
E to C diode forward current	Ι _D	0.8	A
Collector power dissipation	Pc	0.9	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

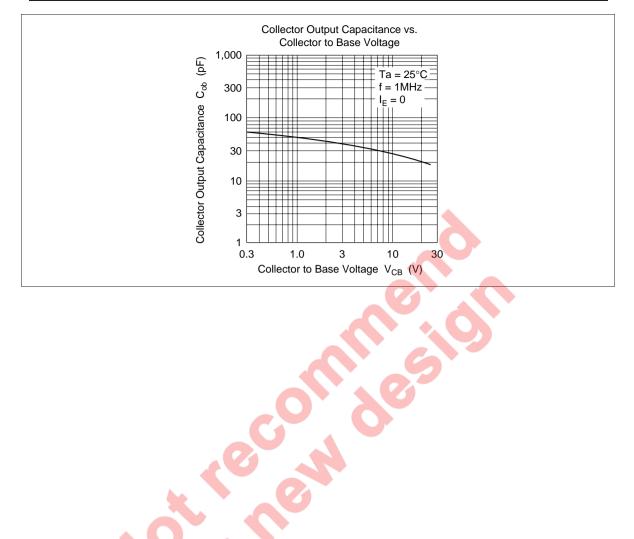
Electrical Characteristics (Ta = 25°C)

Electrical Characteristic	es (Ta = 2	25°C)			3	
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	25	7	-	VS	$I_{c} = 10 \ \mu A, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	25	5	35	V	$I_c = 1 \text{ mA}, R_{BE} = \infty$
Collector to emitter sustaining voltage	V _{CEO(sus)}	25	-	35	V	$I_{c} = 0.8 \text{ A}, \text{ R}_{BE} = \infty,$ L = 20 mH
Emitter to base breakdown voltage	V _{(BR)EBO}	6	-	_	V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{сво}		0_	0.2	μΑ	$V_{CB} = 20 \text{ V}, I_{E} = 0$
	1 _{CEO}	\mathbf{F}		0.5	μΑ	$V_{ce} = 20 \text{ V}, \text{ R}_{be} = \infty$
Emitter cutoff current	I _{EBO}	_		0.2	μΑ	$V_{EB} = 5 V, I_{C} = 0$
DC current transfer ratio	h _{FE}	250	_	1200		$V_{ce} = 2 \text{ V}, \text{ I}_{c} = 0.1 \text{ A}^{*1}$
Collector to emitter saturation voltage	V _{CE(sat)}		—	0.3	V	$I_{c} = 0.8 \text{ A}, I_{B} = 80 \text{ mA}^{*1}$
E to C diode forward voltage	V _D		_	1.1	V	$I_{\rm D} = 0.8 \ {\rm A}^{*1}$
Note: 1. Pulse test						

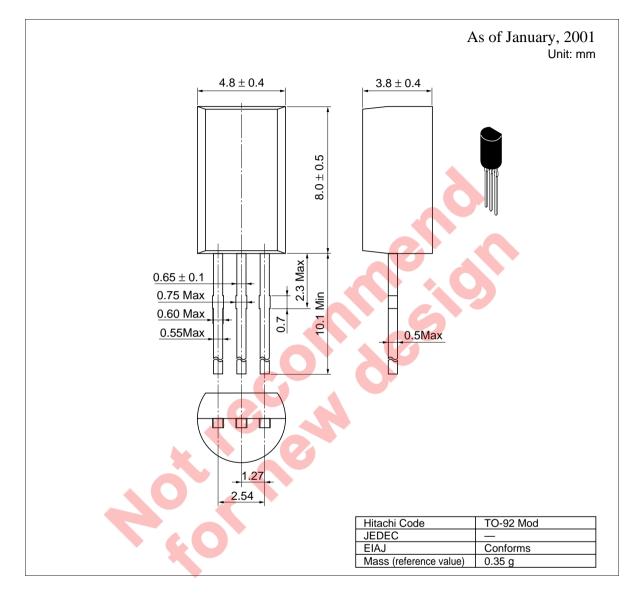
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Package Dimensions



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